NPC

OVERVIEW

The SM5073 series are VCXO ICs with built-in varicap diode. They use a recently developed negative-resistance switching oscillation circuit, at oscillation startup and during normal oscillation, for both good oscillation startup characteristics and wide pullrange. Furthermore, it employs a CMOS process varicap diode, and also features all the necessary VCXO structure circuit components on a single chip, forming a VCXO with just the connection of an external crystal.

FEATURES

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- 3.0 to 3.6V supply voltage range
- 10MHz to 60MHz operating frequency
- (varies with version)
- Uses negative-resistance switching function
- Varicap diode built-in
- Frequency divider built-in (varies with version: f_O, f_O/2, f_O/4, f_O/8, f_O/16, f_O/32)
- CMOS output level
- $50 \pm 10\%$ output duty
- 6mA (min) output drive capability
- 15pF output load capacitance C_L
- Standby function
 High impedance in standby mode (oscillator continues running)
- Package: 8-pin SOP (SM5073××S)

APPLICATIONS

- VCXO modules
- Communications application
- Networking application
- Broadcasting application

SERIES LINEUP

Output frequency **Typical oscillation** Version frequency¹ [MHz] SM5073×1S SM5073×2S² SM5073×3S² SM5073×4S² SM5073×5S² SM5073×6S² SM5073A×S 16 SM5073B×S 23 SM5073C×S 30 f₀/16 f_O/32 $f_0/2$ $f_0/4$ f_∩/8 fo SM5073D×S 37 SM5073E×S 44 SM5073F×S 51

1. The typical oscillation frequency is the oscillation frequency criteria for use when selecting the device version. Note that the oscillation characteristics and pullability vary with the crystal used and the mounting conditions. Even for the same frequency, the optimal version can vary with crystal characteristics, so careful evaluation should be exercised when selecting the device version.

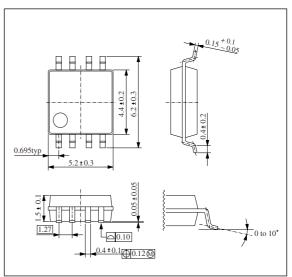
2. These versions are produced after receiving a purchase order. Please ask our Sales & Marketing section for further detail.

ORDERING INFORMATION

Device	Package
SM5073××S	8-pin SOP

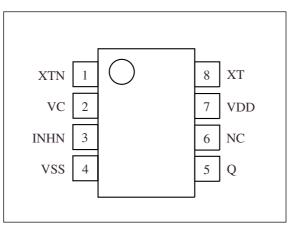
PACKAGE DIMENSIONS

(Unit: mm)



PINOUT

(Top view)

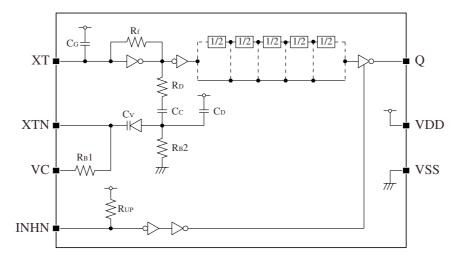


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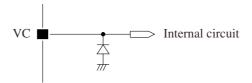
PIN DESCRIPTION

Number	Name	I/O	Description	Function
1	XTN	0	Amplifier output pin	Crystal connection pins. Crystal is connected between XT and XTN.
2	VC	I	Oscillation frequency control voltage input pin	Positive polarity (frequency increases with increasing voltage)
3	INHN	I	Output state control voltage input pin	High-impedance output when LOW, pull-up resistor built-in
4	VSS	-	(-) supply pin	
5	Q	0	Output pin	Output frequency determined by internal circuit to one of $f_O,f_O/2,f_O/4,f_O/8,f_O/16,f_O/32$
6	NC	-	No connection	
7	VDD	-	(+) supply pin	
8	XT	I	Amplifier input pin	Crystal connection pins. Crystal is connected between XT and XTN.

BLOCK DIAGRAM



Note. ESD of XT pin is inferior to other pins. ESD of all pins excluding XT pin is equivalent to that of our other oscillator products. VC pin has no protection circuit at V_{DD} side. (See figure below.)



ABSOLUTE MAXIMUM RATINGS

 $V_{SS} = 0V$ unless otherwise noted.

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage range	V _{DD}		-0.5 to 7.0	V
	V	All input pins excluding VC pin	-0.5 to V _{DD} + 0.5	V
Input voltage range	V _{IN}	VC pin	-0.5 to V _{DD} + 2.5 ¹	V
Output voltage range	V _{OUT}		-0.5 to V _{DD} + 0.5	V
Operating temperature range	T _{opr}		-40 to +85	°C
Storage temperature range	T _{STG}		-55 to +125	°C
Output current	I _{OUT}		20	mA
Power dissipation	PD		500	mW

www.DataSheelt should not exceed + 7.0V.

RECOMMENDED OPERATING CONDITIONS

 V_{SS} = 0V, f = 10MHz to 60MHz, $C_L \leq 15 pF$ unless otherwise noted.

Parameter	Symbol	Symbol Conditions		Rating			
Falanielei	Symbol	Conditions	Min	Тур	Max	Unit	
Operating supply voltage	V _{DD}		3.0	-	3.6	V	
Input voltage	V _{IN}		V _{SS}	-	V _{DD}	V	
Operating temperature	T _{OPR}		-40	-	+85	°C	

ELECTRICAL CHARACTERISTICS

SM5073A×S

Parameter	Cumhol	Conditions			Rating		Unit
Parameter	Symbol	Condition	15	Min	Тур	Max	onn
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	Q: Measurement circuit 1, I _{OH} = 6mA		2.75	-	۷
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	۷
Output leakage current		Q: Measurement circuit 6,	$V_{OH} = V_{DD}$	-	-	10	μA
Oulput leakage current	Ι _Ζ	INHN = LOW	V _{OL} = V _{SS}	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	۷
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
heet4U.com			SM5073A1S	-	8	23	mA
Current concurration		Measurement circuit 2, load circuit 1, INHN = open,	SM5073A2S	-	7.5	22.5	mA
Current consumption	I _{DD}	C _L = 15pF, f = 16MHz	SM5073A3S	-	7	22	mA
			SM5073A4S to 6S	-	7	22	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is		150	300	540	kΩ
	R _D	tested.		0.67	0.96	1.25	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
		Design value. A monitor	$V_{\rm C} = 0.3 V$	11.0	14.4	17.8	pF
	Cv	pattern on a wafer is tested.	V _C = 3.0V	2.4	4.0	5.6	pF
Built-in capacitance	C _G				30	34.5	pF
	CD	Design value. A monitor patte tested.	rn on a wafer is	34	40	46	pF
	C _C			8.5	10	11.5	pF

SM5073B×S

Devenueter	Cumhal	Symbol Conditions			Rating		Unit
Parameter	Symbol	Condition	IS	Min	Тур	Max	Unit
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	_i = 6mA	2.5	2.75	-	V
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	V
Output leakage current	1	Q: Measurement circuit 6,	$V_{OH} = V_{DD}$	-	-	10	μA
Output leakage current	Ιz	INHN = LOW	$V_{OL} = V_{SS}$	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	V
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
		SM		-	9	25	mA
heet4U.com		Measurement circuit 2, load circuit 1, INHN = open,	SM5073B2S	-	8	24	mA
Current consumption	I _{DD}	C _L = 15pF, f = 23MHz	SM5073B3S	-	7.5	23.5	mA
			SM5073B4S to 6S	-	7.5	23.5	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is		150	300	540	kΩ
	R _D	tested.		0.50	0.72	0.94	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
	0	Design value. A monitor	V _C = 0.3V	11.0	14.6	18.2	pF
	Cv	pattern on a wafer is tested.	V _C = 3.0V	2.3	4.0	5.7	pF
Built-in capacitance	C _G			25.5	30	34.5	pF
	CD	Design value. A monitor patte tested.	rn on a wafer is	34	40	46	pF
	C _C			12.7	15	17.3	pF

SM5073C×S

Deveneter	Parameter Symbol Conditions			Rating		Unit	
Parameter	Symbol	Condition	IS	Min	Тур	Max	Unit
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	_i = 6mA	2.5	2.75	-	V
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	V
Output leakage current		Q: Measurement circuit 6,	$V_{OH} = V_{DD}$	-	-	10	μA
Output leakage current	Ιz	INHN = LOW	V _{OL} = V _{SS}	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	V
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
			SM5073C1S	-	10	28	mA
heet4U.com		Measurement circuit 2, load circuit 1, INHN = open,	SM5073C2S	-	9	27	mA
Current consumption	I _{DD}	C _L = 15pF, f = 30MHz	SM5073C3S	-	8.5	26.5	mA
			SM5073C4S to 6S	-	8	26	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is		150	300	540	kΩ
	R _D	tested.		0.50	0.72	0.94	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
	0	Design value. A monitor	V _C = 0.3V	11.0	14.6	18.2	pF
	Cv	pattern on a wafer is tested.	V _C = 3.0V	2.3	4.0	5.7	pF
Built-in capacitance	C _G			25.5	30	34.5	pF
	CD	Design value. A monitor patte tested.	rn on a wafer is	25.5	30	34.5	pF
	C _C			29.7	35	40.3	pF

SM5073D×S

Parameter	Symbol	Condition			Rating		Unit
Parameter	Symbol	Condition	IS	Min	Тур	Max	
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	_i = 6mA	2.5	2.75	-	V
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	V
Output leakage current		Q: Measurement circuit 6,	$V_{OH} = V_{DD}$	-	-	10	μA
	Ιz	INHN = LOW	V _{OL} = V _{SS}	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	V
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
			SM5073D1S	-	11	30	mA
heet4U.com		Measurement circuit 2, load circuit 1, INHN = open,	SM5073D2S	-	9.5	28.5	mA
Current consumption	I _{DD}	C _L = 15pF, f = 37MHz	SM5073D3S	-	9	28	mA
			SM5073D4S to 6S	-	8.5	27.5	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is tested.		150	300	540	kΩ
	R _D			0.25	0.36	0.47	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
		Design value. A monitor	V _C = 0.3V	11.0	14.6	18.2	pF
	Cv	pattern on a wafer is tested.	V _C = 3.0V	2.3	4.0	5.7	pF
Built-in capacitance	C _G			25.5	30	34.5	pF
	CD	Design value. A monitor pattern on a wafer is tested.		25.5	30	34.5	pF
	C _C			34	40	46	pF

SM5073E×S

Parameter	Symbol	Conditions		Rating			Unit
Parameter	Symbol	Condition	IS	Min	Тур	Max	Unit
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	_i = 6mA	2.5	2.75	-	V
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	V
Output leakage current		Q: Measurement circuit 6,	$V_{OH} = V_{DD}$	-	-	10	μA
Output leakage current	Ιz	INHN = LOW	$V_{OL} = V_{SS}$	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	V
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
		Massurament airquit 2 load	SM5073E1S	-	12	32	mA
heet4U.com Current consumption		Measurement circuit 2, load circuit 1, INHN = open,	SM5073E2S	-	10.5	30.5	mA
Current consumption	I _{DD}	C _L = 15pF, f = 44MHz	SM5073E3S	-	9.5	29.5	mA
			SM5073E4S to 6S	-	9	29	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is tested.		150	300	540	kΩ
	R _D			0.25	0.36	0.47	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
	0	Design value. A monitor	V _C = 0.3V	11.0	14.6	18.2	pF
	CV	pattern on a wafer is tested.	V _C = 3.0V	2.3	4.0	5.7	pF
Built-in capacitance	C _G			21.2	25	28.8	pF
	CD	Design value. A monitor patte tested.	rn on a wafer is	21.2	25	28.8	pF
	C _C			42.5	50	57.5	pF

SM5073F×S

Parameter	Symbol	Conditions			Rating		Unit
Parameter	Symbol	Condition	S	Min	Тур	Max	Unit
HIGH-level output voltage	V _{OH}	Q: Measurement circuit 1, I _{OF}	_i = 6mA	2.5	2.75	-	V
LOW-level output voltage	V _{OL}	Q: Measurement circuit 1, I _{OL}	= 6mA	-	0.2	0.4	V
Output leakage current		Q: Measurement circuit 6,	V _{OH} = V _{DD}	-	-	10	μA
Output leakage current	Ιz	INHN = LOW	V _{OL} = V _{SS}	-	-	10	μA
HIGH-level input voltage	V _{IH}	INHN		0.7V _{DD}	-	-	V
LOW-level input voltage	V _{IL}	INHN		-	-	0.3V _{DD}	V
			SM5073F1S	-	13	35	mA
heet4U.com		Measurement circuit 2, load circuit 1, INHN = open,	SM5073F2S	-	11	33	mA
Current consumption	I _{DD}	C _L = 15pF, f = 51MHz	SM5073F3S	-	10	32	mA
			SM5073F4S to 6S	-	9.5	31.5	mA
INHN pull-up resistance	R _{UP}	Measurement circuit 3		50	100	180	kΩ
	R _f	Design value. A monitor pattern on a wafer is		150	300	540	kΩ
	R _D	tested.		0.25	0.36	0.47	kΩ
Built-in resistance	R _{B1}	Measurement circuit 4		100	200	360	kΩ
	R _{B2}	Design value. A monitor patte tested.	rn on a wafer is	50	100	180	kΩ
	0	Design value. A monitor	V _C = 0.3V	9.5	12.5	15.5	pF
	Cv	pattern on a wafer is tested.	V _C = 3.0V	2.0	3.5	5.0	pF
Built-in capacitance	C _G				20	23	pF
	CD	Design value. A monitor patte tested.	rn on a wafer is	17	20	23	pF
	C _C			42.5	50	57.5	pF

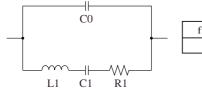
SWITCHING CHARACTERISTICS

 V_{DD} = 3.0 to 3.6V, V_{C} = 1.65V, V_{SS} = 0V, Ta = -40 to +85°C, unless otherwise noted

Devementer	Symbol	Symbol Conditions		Rating ¹			
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Output rise time	t _{r1}	$ \begin{array}{l} \mbox{Measurement circuit 2, load circuit 1,} \\ \mbox{0.1V}_{\mbox{DD}} \rightarrow \mbox{0.9V}_{\mbox{DD}}, \mbox{ C}_{\mbox{L}} = \mbox{15pF} \end{array} $	-	2.5	6	ns	
Output fall time	t _{f1}	$ \begin{array}{l} \mbox{Measurement circuit 2, load circuit 1,} \\ \mbox{0.9V}_{\mbox{DD}} \rightarrow 0.1 \mbox{V}_{\mbox{DD}}, \mbox{C}_{\mbox{L}} = 15 \mbox{pF} \end{array} $	-	2.5	6	ns	
Output duty cycle	Duty	Measurement circuit 2, load circuit 1, $V_{DD} = 3.3V$, Ta = 25°C, $C_L = 15pF$	40	50	60	%	
Output disable delay time	t _{PLZ}	Measurement circuit 5, load circuit 1,	-	-	100	ns	
Output enable delay time	t _{PZL}	$V_{DD} = 3.3V$, Ta = 25°C, C _L \leq 15pF	-	-	100	ns	

www.DataShe The switching characteristics apply for normal output waveforms. Note that, depending on the matching of the SM5073 series version and crystal, normal waveform output may not be continuous.

Current consumption and Output waveform with NPC's standard crystal



f [MHz]	R1 [Ω]	L1 [mH]	C1 [fF]	C0 [pF]
30	7.06	2.25	12.5	3.11

FUNCTIONAL DESCRIPTION

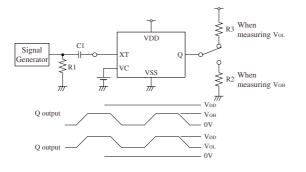
Standby Function

When INHN goes LOW, the Q output pin becomes high impedance.

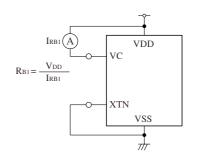
INHN	Q	Oscillator
HIGH (or open)	Any f_{O} , $f_{O}/2$, $f_{O}/4$, $f_{O}/8$, $f_{O}/16$, or $f_{O}/32$	Operating
LOW	High impedance	Operating

MEASUREMENT CIRCUITS

Measurement Circuit 1

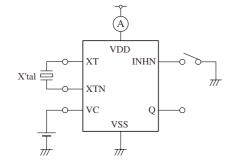






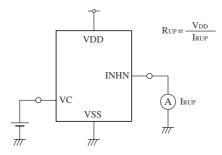
www.DataSheet411.com XT input signal: 2.5Vp-p, 10MHz, sine wave C1 = 0.001 μ F, R1 = 50 Ω , R2 = 417 Ω , R3 = 434 Ω , V_C = 1.65V

Measurement Circuit 2



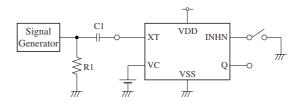
 V_C = 1.65V, INHN = open, crystal oscillation

Measurement Circuit 3



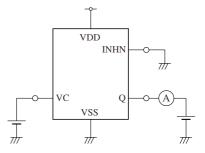
V_C = 1.65V

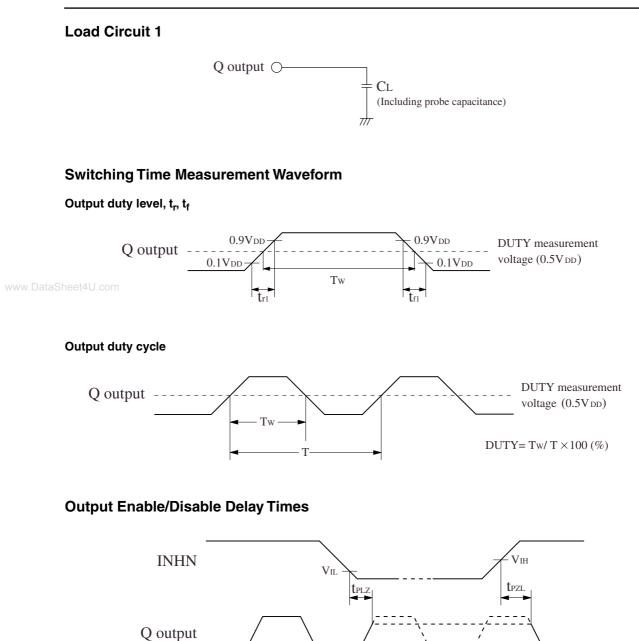
Measurement Circuit 5



XT input signal: 2.5Vp-p, 10MHz, sine wave C1 = 0.001 μ F, R1 = 50 Ω , V_C = 1.65V

Measurement Circuit 6





INHN input waveform $tr = tf \le 10ns$

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Please pay your attention to the following points at time of using the products shown in this document.

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SEIKO NPC CORPORATION

15-6, Nihombashi-kabutocho, Chuo-ku, Tokyo 103-0026, Japan Telephone: +81-3-6667-6601 Facsimile: +81-3-6667-6611 http://www.npc.co.jp/ Email: sales@npc.co.jp

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